

# 100V, 2.5A, High Frequency Half-bridge Gate Driver

#### DESCRIPTION

The MP1907 is a high frequency, 100V half bridge N-channel power MOSFET driver. Its low side and high side driver channels are independently controlled and matched with less than 5ns in time delay. Under-voltage lock-out both high side and low side supplies force their outputs low in case of insufficient supply. Both outputs will remain low until a rising edge on either input is detected. The integrated bootstrap diode reduces external component count.

## **FEATURES**

- Drives N-channel MOSFET half bridge
- 100V V<sub>BST</sub> voltage range
- Input signal overlap protection
- On-chip bootstrap diode
- Typical 20ns propagation delay time
- Less than 5ns gate drive mismatch
- Drive 1nF load with 12ns/9ns rise/fall times with 12V VDD
- TTL compatible input
- Less than 150µA quiescent current
- Less than 5µA shutdown current
- UVLO for both high side and low side
- In 3×3mm QFN10 Packages

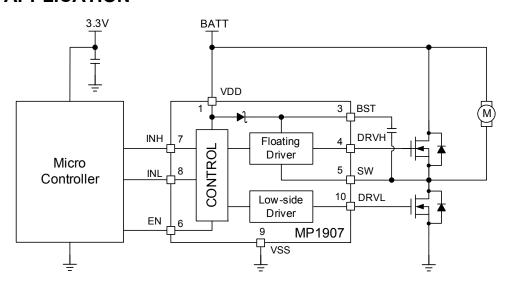
#### **APPLICATIONS**

- Battery Powered Hand Tool
- Telecom half bridge power supplies
- Avionics DC-DC converters
- Active-clamp Forward Converters

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## TYPICAL APPLICATION



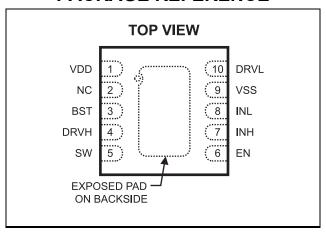


## ORDERING INFORMATION

Part Number*	Package	Top Marking		
MP1907GQ	QFN10 (3 x 3 mm)	ADE		

\* For Tape & Reel, add suffix –Z (e.g. MP1907GQ–Z);

## **PACKAGE REFERENCE**



# **ABSOLUTE MAXIMUM RATINGS** (1)

Supply Voltage (V <sub>DD</sub> )SW Voltage (V <sub>SW</sub> )	
BST Voltage (V <sub>BST</sub> )	
BST to SW	0.3V to +18V
DRVH to SW0.3V to	(BST-SW) +0.3V
DRVL to VSS0.	$.3V \text{ to } (V_{DD} + 0.3V)$
All Other Pins	0.3V to 20V
Continuous Power Dissipation	$(T_A = +25^{\circ}C)^{(2)}$
QFN10 (3x3)	2.5W
Junction Temperature	150°C
Lead Temperature	260°C
Storage Temperature	-65°C to +150°C

# Recommended Operating Conditions (3)

Recommended Operating	
Supply Voltage (V <sub>DD</sub> )	. +4.5V to 18V <sup>(4)</sup>
SW Voltage (V <sub>SW</sub> )	1.0V to 100V
SW slew rate	<50V/nsec
Operating Junction Temp. (T <sub>J</sub> ).	-40°C to +125°C

Thermal Resistance (5)	$oldsymbol{ heta}_{JA}$	$\boldsymbol{\theta}_{JC}$	
QFN10 (3x3)	50	. 12	°C/W

#### Notes:

- 1) Exceeding these ratings may damage the device.
  - 2) The maximum allowable power dissipation is a function of the maximum junction temperature  $T_J$  (MAX), the junction-to-ambient thermal resistance  $\theta_{JA}$ , and the ambient temperature  $T_A$ . The maximum allowable continuous power dissipation at any ambient temperature is calculated by  $P_D$  (MAX) =  $(T_J$  (MAX)- $T_A$ )/ $\theta_{JA}$ . Exceeding the maximum allowable power dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- The device is not guaranteed to function outside of its operating conditions.
- 4.5V is only a typical value for minimum supply voltage at V<sub>DD</sub> falling
- 5) Measured on JESD51-7, 4-layer PCB.



## **ELECTRICAL CHARACTERISTICS**

 $V_{DD}$  =  $V_{BST}$ - $V_{SW}$ =12V,  $V_{SS}$ = $V_{SW}$  = 0V,  $V_{EN}$ =3.3V, No load at DRVH and DRVL,  $T_A$ = +25°C, unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур	Max	Units
Supply Current						
VDD Shutdown Current	I <sub>SHDN</sub>	V <sub>EN</sub> =0,		0	1	μA
VDD quiescent current	I <sub>DDQ</sub>	INL=INH=0		80	100	μΑ
VDD operating current	I <sub>DDO</sub>	fsw=500kHz		2.8	3.5	mA
Floating driver quiescent current	I <sub>BSTQ</sub>	INL=0, INH=0 or 1		55	70	μA
Floating driver operating current	I <sub>BSTO</sub>	fsw=500kHz		2.1	3	mA
Leakage Current	I <sub>LK</sub>	BST=SW=100V		0.05	1	μА
Inputs		1				
INL/INH High			2.4			V
INL/INH Low					1	V
INL/INH Hysteresis				0.6		V
INL/INH internal pull-down resistance	R <sub>IN</sub>			185		kΩ
Under Voltage Protection		1				
VDD rising threshold	$V_{DDR}$		4.6	5.0	5.4	V
VDD falling threshold	$V_{DDF}$		4.1	4.5	4.9	V
(BST-SW) rising threshold	$V_{BSTR}$		4.6	5.0	5.4	V
(BST-SW) falling threshold	$V_{BSTF}$		4.1	4.5	4.9	V
EN Input Logic Low					0.7	V
EN Input Logic High			1.5			V
EN Hysteresis				100		mV
EN land Comment		V <sub>EN</sub> =2V, T <sub>A</sub> =+25°C		10		μA
EN Input Current	I <sub>EN</sub>	V <sub>EN</sub> =5V, T <sub>A</sub> =-10°C to +70°C			35 <sup>(6)</sup>	μA
EN internal pull-down resistance	R <sub>EN</sub>			200		kΩ
Bootstrap Diode		1				
Bootstrap diode VF @ 100uA	$V_{F1}$			0.55		V
Bootstrap diode VF @ 100mA	$V_{F2}$			1		V
Bootstrap diode dynamic R	$R_D$	@ 100mA		2.7		Ω
Low Side Gate Driver				•		
Low level output voltage	$V_{OLL}$	I <sub>O</sub> =100mA		0.15	0.22	V
High level output voltage to rail	$V_{OHL}$	I <sub>O</sub> =-100mA		0.45	0.6	V
		V <sub>DRVL</sub> =0V, V <sub>DD</sub> =4.5V <sup>(8)</sup>		0.15		Α
Peak pull-up current <sup>(7)</sup>	I <sub>OHL</sub>	V <sub>DRVL</sub> =0V, V <sub>DD</sub> =12V		1.5		Α
		V <sub>DRVL</sub> =0V, V <sub>DD</sub> =16V		2.5		Α
		V <sub>DRVL</sub> =V <sub>DD</sub> =4.5V <sup>(8)</sup>		0.25		Α
Peak pull-down current <sup>(7)</sup>	I <sub>OLL</sub>	V <sub>DRVL</sub> =V <sub>DD</sub> =12V		2.5		Α
		V <sub>DRVL</sub> =V <sub>DD</sub> =16V		3.5		Α
Floating Gate Driver		I	ı	1	1	1
Low level output voltage	$V_{OLH}$	I <sub>O</sub> =100mA		0.15	0.22	V



# **ELECTRICAL CHARACTERISTICS** (continued)

 $V_{DD} = V_{BST} - V_{SW} = 12V$ ,  $V_{SS} = V_{SW} = 0V$ ,  $V_{EN} = 3.3V$ , No load at DRVH and DRVL,  $T_A = +25$ °C, unless otherwise noted.

Parameter	Symbol	Condition	Min	Тур	Max	Units
High level output voltage to rail	$V_{OHH}$	I <sub>O</sub> =-100mA		0.45	0.6	V
		$V_{DRVH}$ =0V , $V_{BST}$ - $V_{SW}$ =5V $^{(9)}$		0.25		Α
Peak pull-up current <sup>(7)</sup>	$I_{OHH}$	V <sub>DRVH</sub> =0V, V <sub>DD</sub> =12V		1.5		Α
		V <sub>DRVH</sub> =0V, V <sub>DD</sub> =16V		2.5		Α
		V <sub>DRVH</sub> =V <sub>BST</sub> - V <sub>SW</sub> =5V <sup>(9)</sup>		0.65		Α
Peak pull-down current <sup>(7)</sup>	$I_{OLH}$	V <sub>DRVH</sub> =V <sub>DD</sub> =12V		2.5		Α
		V <sub>DRVH</sub> =V <sub>DD</sub> =16V		3.5		Α
Switching Spec Low Side Gate	e Driver					
Turn-off propagation delay INL falling to DRVL falling	$T_DLFF$			20		ns
Turn-on propagation delay INL rising to DRVL rising	$T_{DLRR}$			20		ns
DRVL rise time		C <sub>L</sub> =1nF		12		ns
DRVL fall time		C <sub>L</sub> =1nF		9		ns
Switching Spec Floating Gate	Driver					
Turn-off propagation delay INL falling to DRVH falling	$T_{DHFF}$			20		ns
Turn-on propagation delay INL rising to DRVH rising	$T_{DHRR}$			18		ns
DRVH rise time		C <sub>L</sub> =1nF		12		ns
DRVH fall time		C <sub>L</sub> =1nF		9		ns
Switching Spec Matching						
Floating driver turn-off to low side drive turn-on	$T_MON$			1	5	ns
Low side driver turn-off to floating driver turn-on	T <sub>MOFF</sub>			1	5	ns
Minimum input pulse width that changes the output	$T_PW$				50 <sup>(7)</sup>	ns
Bootstrap diode turn-on or turn-off time	T <sub>BS</sub>			10 <sup>(7)</sup>		ns

#### Note:

- 6) Based on characterization data. Not production tested.
- 7) Guaranteed by design.
- 8) After startup VDD fall to 4.5V
- 9) After startup VBST- VSW fall to 5V

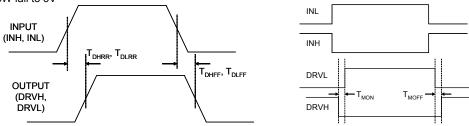


Figure 1—Timing Diagram



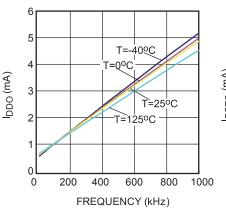
## **PIN FUNCTIONS**

Package Pin#	Name	Description
1	VDD	Supply input. This pin supplies power to all the internal circuitry. A decoupling capacitor to ground must be placed close to this pin to ensure stable and clean supply.
2	NC	No Connection.
3	BST	Bootstrap. This is the positive power supply for the internal floating high-side MOSFET driver. Connect a bypass capacitor between this pin and SW pin.
4	DRVH	Floating driver output.
5	SW	Switching node.
6	EN	On/off Control.
7	INH	Control signal input for the floating driver.
8	INL	Control signal input for the low side driver.
9	VSS, Exposed Pad	Chip ground. Connect to Exposed pad to VSS for proper thermal operation.
10	DRVL	Low side driver output.

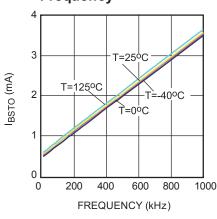


## TYPICAL PERFORMANCE CHARACTERISTICS

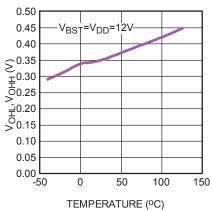
 $V_{DD}$  =12V,  $V_{SS}$ = $V_{SW}$  = 0V,  $T_A$ = +25°C, unless otherwise noted. **IDDO** Operation Current vs. Frequency



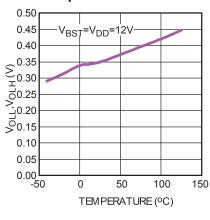
**IBSTO Operation Current vs.** Frequency



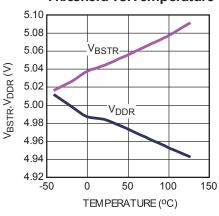
**High Level Output** Voltage vs. Temperature



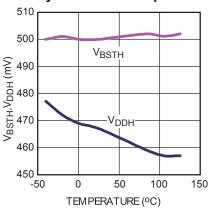
Low Level Output Voltage vs. **Temperature** 



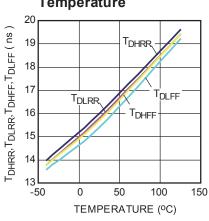
**Undervoltage Lockout** Threshold vs. Temperature



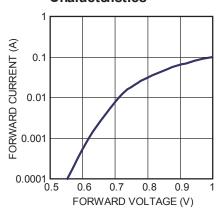
**Undervoltage Lockout** Hysteresis vs. Temperature



Propagation Delay vs. **Temperature** 

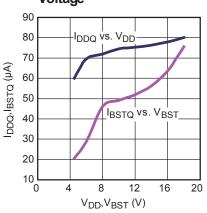


**Bootstrap Diode I-V** Characteristics



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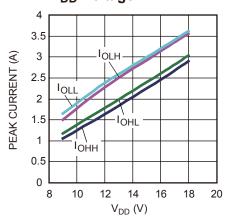
Quiescent Current vs. Voltage





 $V_{DD}$  =12V,  $V_{SS}$ = $V_{SW}$  = 0V,  $T_A$ = +25°C, unless otherwise noted.

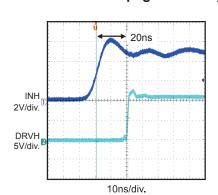
Peak Current vs. V<sub>DD</sub> Voltage

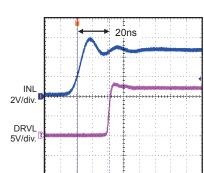


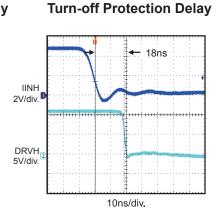
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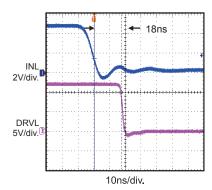
 $V_{DD}$  =12V,  $V_{SS}$ = $V_{SW}$  = 0V,  $T_A$ = +25°C, unless otherwise noted. Turn-on Propagation Delay Turn-on Propagation Delay





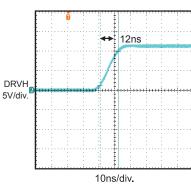


**Turn-off Protection Delay** 

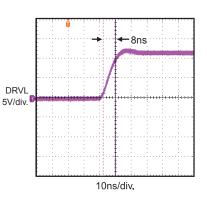




10ns/div.

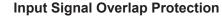


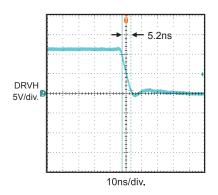
**Drive Rise Time (1nF Load)** 

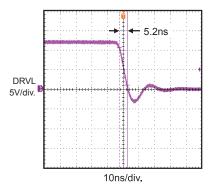


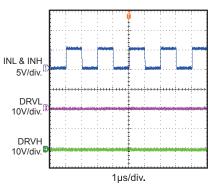
**Drive Fall Time (1nF Load)** 

**Drive Fall Time (1nF Load)** 



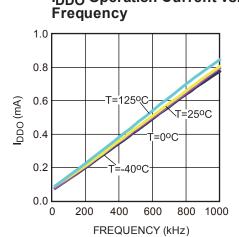


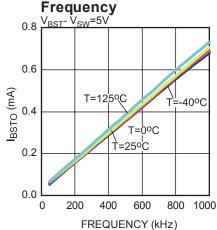


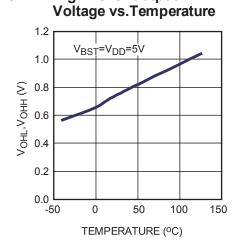




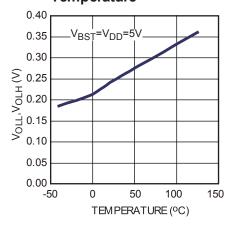
 $V_{DD}$  =5V, after startup  $V_{DD}$  falls to 5V,  $V_{SS}$ = $V_{SW}$  = 0V,  $T_A$ = +25°C, unless otherwise noted.  $I_{DDO}$  Operation Current vs.  $I_{BSTO}$  Operation Current vs. High Level Output



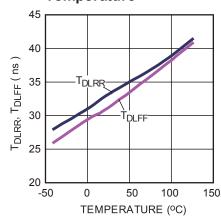




Low Level Output Voltage vs. Temperature

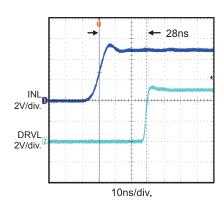


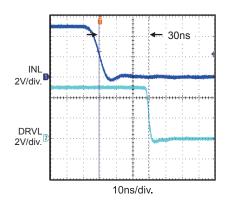
Propagation Delay vs. Temperature

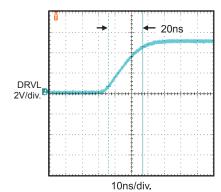




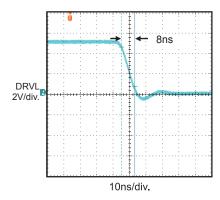
 $V_{DD}$  =5V, after startup  $V_{DD}$  falls to 5V,  $V_{SS}$ = $V_{SW}$  = 0V,  $T_A$ = +25°C, unless otherwise noted. Turn-on Propagation Delay Turn-off Propagation Delay Drive Rise Time (1nF Load)







## **Drive Fall Time (1nF Load)**



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## **BLOCK DIAGRAM**

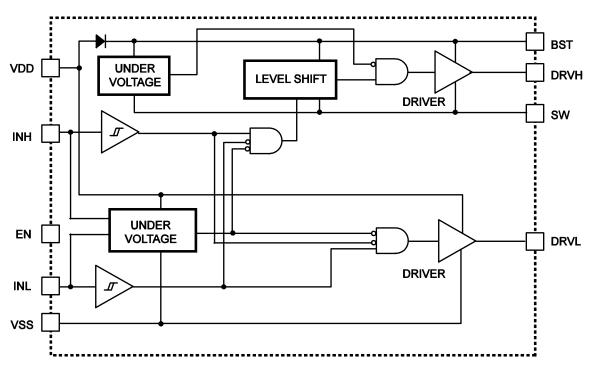


Figure 2—Function Block Diagram



#### **OPERATION**

## **Switch Shoot-through Protection**

The input signals of INH and INL are controlled independently. Input shoot-through protection circuitry is implemented to prevent shoot-through between the HSFET and LSFET outputs. Only one of the FET drivers can be ON at one time. If both INH and INL are high at the same time, both HSFET and LSFET will be OFF.

## **Under Voltage Lock Out**

When VDD or BST goes below their respective UVLO thresholds, both DRVH and DRVL outputs will go low to turn off both FETs. Once VDD rises above the UVLO threshold, both DRVH and DRVL will stay low until a rising edge is detected on either INH or INL.

The truth table in Table 1 details the operation of the HSFET and LSFET under different INH, INL and UVLO conditions

**Table1 States of Driver Output under different conditions** 

EN	BST-SW Voltage	V <sub>DD</sub> Voltage	INH	INL	DRVH	DRVL	UVLO Latch status	Operating Condition
0	Х	X	Х	Х	Open	200kΩ pull down	Х	Х
	Х	Х	0	0	0	0	Х	
	Х	Х	1	1	0	0	Х	
	X	Above UVLO	0	1	0	1	Normal	Normal Operation
	Above UVLO	Above UVLO	1	0	1	0	Normal	
	Falls below UVLO	Above UVLO	Х	Х	0	0	Normal to Tripped	Normal-to-Tripped
	Above UVLO	Falls below UVLO	Х	Х	0	0	Normal to Tripped	Transition
	Х	Above UVLO	0 or 1	0 or 1	0	0	Tripped	When UVLO latch is
	Х	Below UVLO	Х	Х	0	0	Tripped	tripped.
1	X	Above UVLO	0 to 1	0 to 1	0	0	Tripped, Reset by INL & INH	
	Х	Above UVLO	1 to 0	1	0	0 to 1	Tripped, Reset by INH Falling	
	Below UVLO	Above UVLO	1	1 to 0	0	0	Tripped, Reset by INL Falling	
	Above UVLO	Above UVLO	1	1 to 0	0 to 1	0	Tripped, Reset by INL Falling	Tripped to Normal Transition
	Below UVLO	Above UVLO	0	0 to 1	0	0 to 1	Tripped, Reset by INL	
	Below UVLO	Above UVLO	0 to 1	0	0	0	Tripped, Reset by INH	
	Above UVLO	Above UVLO	0 to 1	0	0 to 1	0	Tripped, Reset by INH	

Note: x = Don't Care.

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## **APPLICATION INFORMATION**

# Reference Design Circuits Half Bridge Motor Driver

T In half-bridge converter topology, the MOSFETs are driven alternately with some dead time. Therefore, INH and INL are driven with

alternating signals from the PWM controller. The input voltage can be up to 100V in this application.

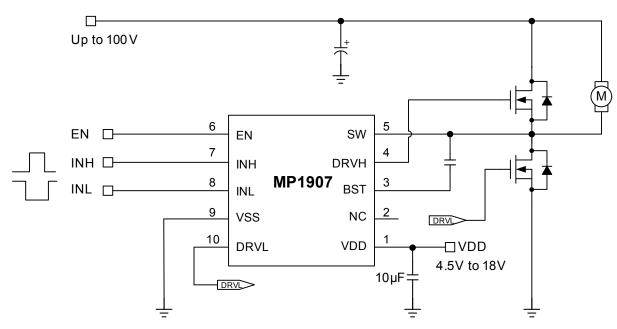


Figure 3—Half-Bridge Motor Driver



## **Active-Clamp Forward Converter**

In active-clamp forward converter topology, the MOSFETs are driven alternately. The high-side MOSFET, along with capacitor  $C_{\text{reset}}$ , is used to reset the power transformer in a lossless manner.

This topology lends itself well to run at duty cycles exceeding 50%. For these reasons, the input voltage may not be able to run at 100V for this application.

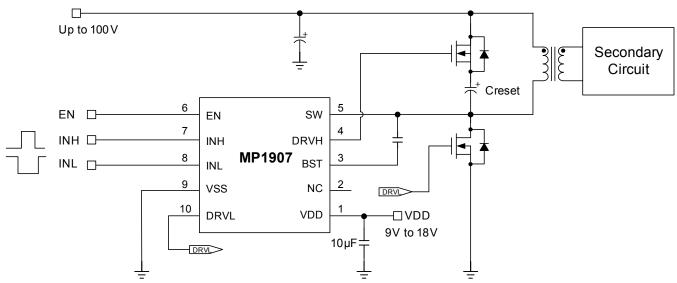
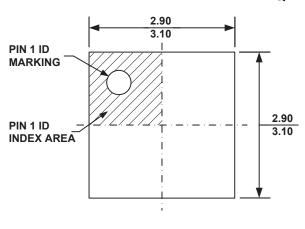


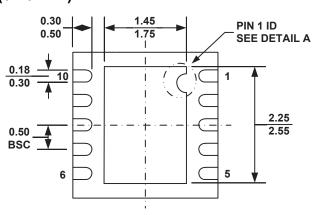
Figure 4—Active-clamp Forward Converter



## PACKAGE INFORMATION

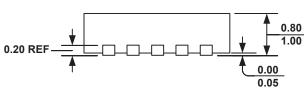
## QFN10 (3 ×3 mm)



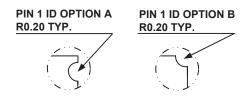


**TOP VIEW** 

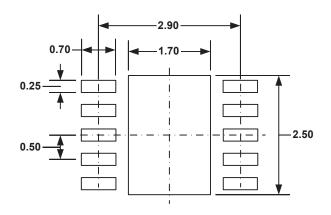
**BOTTOM VIEW** 



**SIDE VIEW** 



**DETAIL A** 



#### **NOTE:**

- 1) ALL DIMENSIONS ARE IN MILLIMETERS.
- 2) EXPOSED PADDLE SIZE DOES NOT INCLUDE MOLD FLASH.
- 3) LEAD COPLANARITY SHALL BE 0.10 MILLIMETER MAX.
- 4) DRAWING CONFORMS TO JEDEC MO-229, VARIATION VEED-5.
- 5) DRAWING IS NOT TO SCALE.

#### **RECOMMENDED LAND PATTERN**

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